Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Wei-Chieh Lin	01/14/2009
Ho-Tai Chen	01/14/2009
Li-Cheng Lin	01/14/2009
Jen-Hao Yeh	01/14/2009
Hsin-Yen Chiu	01/14/2009
Hsin-Yu Hsu	01/14/2009
Shih-Chieh Hung	01/14/2009

RECEIVING PARTY DATA

Name:	Anpec Electronics Corporation	
Street Address:	No. 6, Dusing 1St Rd., Hsinchu Science Park	
City:	Hsin-Chu	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12371618

CORRESPONDENCE DATA

Fax Number: (703)997-4517

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 3027291562

Email: Patent.admin.uspto.cr@naipo.com

Correspondent Name: WINSTON HSU Address Line 1: P.O.BOX 506

Address Line 4: Merrifield, VIRGINIA 22116

ATTORNEY DOCKET NUMBER:	ANPP0029USA
NAME OF SUBMITTER:	WINSTON HSU
	PATENT

500781845 **REEL: 022258 FRAME: 0632**

Total Attachments: 3 source=570874#page1.tif source=570874#page2.tif source=570874#page3.tif

> PATENT REEL: 022258 FRAME: 0633

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S) (Inventors):

Name:	Wei-Chieh Lin	Nationality:	TWN
Name:	Ho-Tai Chen	Nationality:	TWN
Name:	Li-Cheng Lin	Nationality:	TWN
Name:	Jen-Hao Yeh	Nationality:	TWN
Name:	Hsin-Yen Chiu	Nationality:	TWN
Name:	Hsin-Yu Hsu	Nationality:	TWN
Name:	Shih-Chieh Hung	Nationality:	TWN
Hereby sells, assigns and transfers to			
ASSIGNEE(S			
Name:	Anpec Electronics Corporation		
	•		
Address:	No. 6, Dusing 1St Rd., Hsinchu Science	Park, Hsin-Chu 300,	Taiwan, R.O.C.

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"Semiconductor Device for Improving the Peak Induced Voltage in Switching Converter"

Whi	ch is fou	and in:		
(a) _	+	U.S. patent application execu	ited on even date	
(b)_		U.S. patent application execu	ıted on	
(c)_		_ U.S. application serial no		_
(d) _		patent no.	issued	

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this Jan. 14, 2009 (Date of signing). (磷發明人務必簽署上列目期。)

(Type name of inventor)	Signature of INVENTOR
Wei-Chieh Lin	Wei-Chieh LIN
Ho-Tai Chen	Ho-Tat Chen
Li-Cheng Lin	Li-Chey Lin
Jen-Hao Yeh	Jen Hav Joh
	HSIN-YEN CHIU
Hsin-Yen Chiu	Hern - Yu Hiu
Hsin-Yu Hsu	
Shih-Chieh Hung	Shah-Chaeh Mung

Assignment, Page 3 of 3

F#NPO-P0002E-US1 DSB0-097U031685

NPO#ANP-P0029-USA:0 CUST#97005

RECORDED: 02/15/2009